



Welcome to [E-XFL.COM](http://E-XFL.COM)

### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	13
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	18-DIP (0.300", 7.62mm)
Supplier Device Package	18-PDIP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16c622-04i-p">https://www.e-xfl.com/product-detail/microchip-technology/pic16c622-04i-p</a>

# PIC16C62X

---

## Device Differences

Device	Voltage Range	Oscillator	Process Technology (Microns)
PIC16C620 <sup>(3)</sup>	2.5 - 6.0	See <b>Note 1</b>	0.9
PIC16C621 <sup>(3)</sup>	2.5 - 6.0	See <b>Note 1</b>	0.9
PIC16C622 <sup>(3)</sup>	2.5 - 6.0	See <b>Note 1</b>	0.9
PIC16C620A <sup>(4)</sup>	2.7 - 5.5	See <b>Note 1</b>	0.7
PIC16CR620A <sup>(2)</sup>	2.5 - 5.5	See <b>Note 1</b>	0.7
PIC16C621A <sup>(4)</sup>	2.7 - 5.5	See <b>Note 1</b>	0.7
PIC16C622A <sup>(4)</sup>	2.7 - 5.5	See <b>Note 1</b>	0.7

**Note 1:** If you change from this device to another device, please verify oscillator characteristics in your application.

**2:** For ROM parts, operation from 2.5V - 3.0V will require the PIC16LCR62X parts.

**3:** For OTP parts, operation from 2.5V - 3.0V will require the PIC16LC62X parts.

**4:** For OTP parts, operations from 2.7V - 3.0V will require the PIC16LC62XA parts.

## 2.0 PIC16C62X DEVICE VARIETIES

A variety of frequency ranges and packaging options are available. Depending on application and production requirements, the proper device option can be selected using the information in the PIC16C62X Product Identification System section at the end of this data sheet. When placing orders, please use this page of the data sheet to specify the correct part number.

### 2.1 UV Erasable Devices

The UV erasable version, offered in CERDIP package, is optimal for prototype development and pilot programs. This version can be erased and reprogrammed to any of the Oscillator modes.

Microchip's PICSTART® and PRO MATE® programmers both support programming of the PIC16C62X.

<b>Note:</b> Microchip does not recommend code protecting windowed devices.
---

### 2.2 One-Time-Programmable (OTP) Devices

The availability of OTP devices is especially useful for customers who need the flexibility for frequent code updates and small volume applications. In addition to the program memory, the configuration bits must also be programmed.

### 2.3 Quick-Turnaround-Production (QTP) Devices

Microchip offers a QTP programming service for factory production orders. This service is made available for users who chose not to program a medium to high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices, but with all EPROM locations and configuration options already programmed by the factory. Certain code and prototype verification procedures apply before production shipments are available. Please contact your Microchip Technology sales office for more details.

### 2.4 Serialized Quick-Turnaround-Production<sup>SM</sup> (SQTP<sup>SM</sup>) Devices

Microchip offers a unique programming service where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random or sequential.

Serial programming allows each device to have a unique number, which can serve as an entry-code, password or ID number.

# PIC16C62X

## 4.2.2.1 STATUS Register

The STATUS register, shown in Register 4-1, contains the arithmetic status of the ALU, the RESET status and the bank select bits for data memory.

The STATUS register can be the destination for any instruction, like any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, `CLRF STATUS` will clear the upper-three bits and set the Z bit. This leaves the STATUS register as 000uu1uu (where u = unchanged).

It is recommended, therefore, that only `BCF`, `BSF`, `SWAPF` and `MOVWF` instructions are used to alter the STATUS register, because these instructions do not affect any STATUS bit. For other instructions not affecting any STATUS bits, see the "Instruction Set Summary".

**Note 1:** The IRP and RP1 bits (STATUS<7:6>) are not used by the PIC16C62X and should be programmed as '0'. Use of these bits as general purpose R/W bits is NOT recommended, since this may affect upward compatibility with future products.

**2:** The C and DC bits operate as a Borrow and Digit Borrow out bit, respectively, in subtraction. See the `SUBLW` and `SUBWF` instructions for examples.

## REGISTER 4-1: STATUS REGISTER (ADDRESS 03H OR 83H)

Reserved	Reserved	R/W-0	R-1	R-1	R/W-x	R/W-x	R/W-x
IRP	RP1	RP0	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Z	DC	C
bit 7							bit 0

- bit 7 **IRP:** Register Bank Select bit (used for indirect addressing)  
 1 = Bank 2, 3 (100h - 1FFh)  
 0 = Bank 0, 1 (00h - FFh)  
 The IRP bit is reserved on the PIC16C62X; always maintain this bit clear.
- bit 6-5 **RP<1:0>:** Register Bank Select bits (used for direct addressing)  
 01 = Bank 1 (80h - FFh)  
 00 = Bank 0 (00h - 7Fh)  
 Each bank is 128 bytes. The RP1 bit is reserved on the PIC16C62X; always maintain this bit clear.
- bit 4  **$\overline{\text{TO}}$ :** Time-out bit  
 1 = After power-up, `CLRWDT` instruction, or `SLEEP` instruction  
 0 = A WDT time-out occurred
- bit 3  **$\overline{\text{PD}}$ :** Power-down bit  
 1 = After power-up or by the `CLRWDT` instruction  
 0 = By execution of the `SLEEP` instruction
- bit 2 **Z:** Zero bit  
 1 = The result of an arithmetic or logic operation is zero  
 0 = The result of an arithmetic or logic operation is not zero
- bit 1 **DC:** Digit carry/borrow bit (`ADDWF`, `ADDLW`, `SUBLW`, `SUBWF` instructions)(for borrow the polarity is reversed)  
 1 = A carry-out from the 4th low order bit of the result occurred  
 0 = No carry-out from the 4th low order bit of the result
- bit 0 **C:** Carry/borrow bit (`ADDWF`, `ADDLW`, `SUBLW`, `SUBWF` instructions)  
 1 = A carry-out from the Most Significant bit of the result occurred  
 0 = No carry-out from the Most Significant bit of the result occurred
- Note:** For borrow the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (`RRF`, `RLF`) instructions, this bit is loaded with either the high or low order bit of the source register.

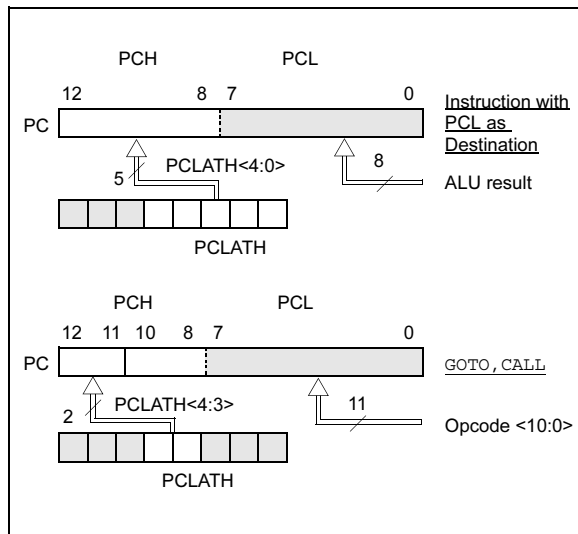
### Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared    x = Bit is unknown

## 4.3 PCL and PCLATH

The program counter (PC) is 13-bits wide. The low byte comes from the PCL register, which is a readable and writable register. The high byte (PC<12:8>) is not directly readable or writable and comes from PCLATH. On any RESET, the PC is cleared. Figure 4-8 shows the two situations for the loading of the PC. The upper example in the figure shows how the PC is loaded on a write to PCL (PCLATH<4:0> → PCH). The lower example in the figure shows how the PC is loaded during a CALL or GOTO instruction (PCLATH<4:3> → PCH).

**FIGURE 4-8: LOADING OF PC IN DIFFERENT SITUATIONS**



### 4.3.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When doing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256 byte block). Refer to the application note, "Implementing a Table Read" (AN556).

### 4.3.2 STACK

The PIC16C62X family has an 8-level deep x 13-bit wide hardware stack (Figure 4-2 and Figure 4-3). The stack space is not part of either program or data space and the stack pointer is not readable or writable. The PC is PUSHed onto the stack when a CALL instruction is executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a PUSH or POP operation.

The stack operates as a circular buffer. This means that after the stack has been PUSHed eight times, the ninth push overwrites the value that was stored from the first push. The tenth push overwrites the second push (and so on).

**Note 1:** There are no STATUS bits to indicate stack overflow or stack underflow conditions.

**2:** There are no instructions/mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, RETURN, RETLW and RETFIE instructions, or the vectoring to an interrupt address.

## 6.0 TIMER0 MODULE

The Timer0 module timer/counter has the following features:

- 8-bit timer/counter
- Readable and writable
- 8-bit software programmable prescaler
- Internal or external clock select
- Interrupt on overflow from FFh to 00h
- Edge select for external clock

Figure 6-1 is a simplified block diagram of the Timer0 module.

Timer mode is selected by clearing the T0CS bit (OPTION<5>). In Timer mode, the TMR0 will increment every instruction cycle (without prescaler). If Timer0 is written, the increment is inhibited for the following two cycles (Figure 6-2 and Figure 6-3). The user can work around this by writing an adjusted value to TMR0.

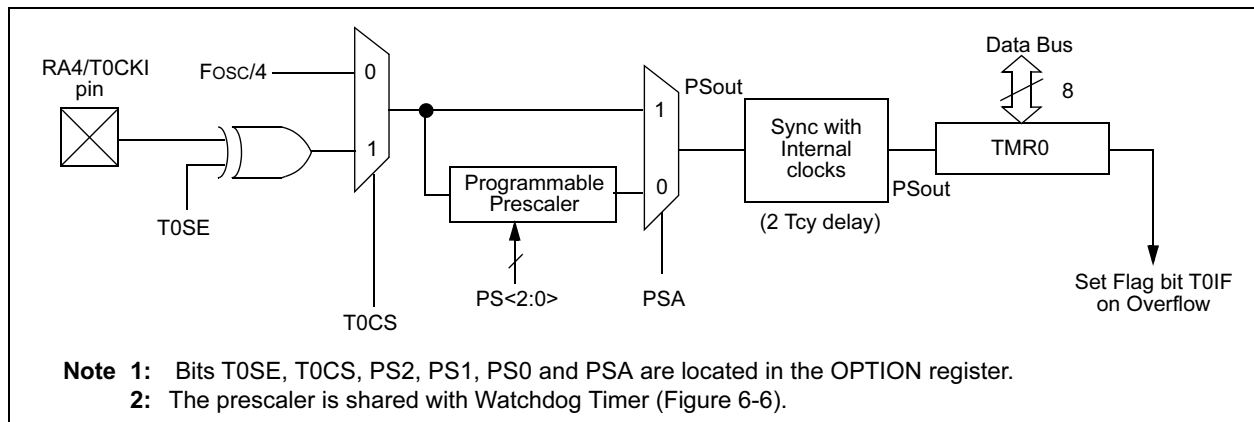
Counter mode is selected by setting the T0CS bit. In this mode, Timer0 will increment either on every rising or falling edge of pin RA4/T0CKI. The incrementing edge is determined by the source edge (T0SE) control bit (OPTION<4>). Clearing the T0SE bit selects the rising edge. Restrictions on the external clock input are discussed in detail in Section 6.2.

The prescaler is shared between the Timer0 module and the Watchdog Timer. The prescaler assignment is controlled in software by the control bit PSA (OPTION<3>). Clearing the PSA bit will assign the prescaler to Timer0. The prescaler is not readable or writable. When the prescaler is assigned to the Timer0 module, prescale value of 1:2, 1:4, ..., 1:256 are selectable. Section 6.3 details the operation of the prescaler.

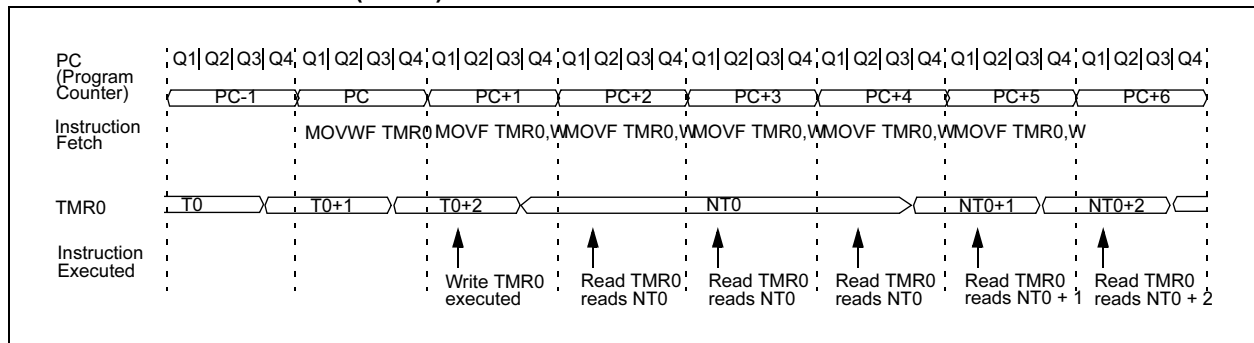
### 6.1 TIMER0 Interrupt

Timer0 interrupt is generated when the TMR0 register timer/counter overflows from FFh to 00h. This overflow sets the T0IF bit. The interrupt can be masked by clearing the T0IE bit (INTCON<5>). The T0IF bit (INTCON<2>) must be cleared in software by the Timer0 module interrupt service routine before re-enabling this interrupt. The Timer0 interrupt cannot wake the processor from SLEEP, since the timer is shut off during SLEEP. See Figure 6-4 for Timer0 interrupt timing.

**FIGURE 6-1: TIMER0 BLOCK DIAGRAM**



**FIGURE 6-2: TIMER0 (TMR0) TIMING: INTERNAL CLOCK/NO PRESCALER**





## 9.2 Oscillator Configurations

### 9.2.1 OSCILLATOR TYPES

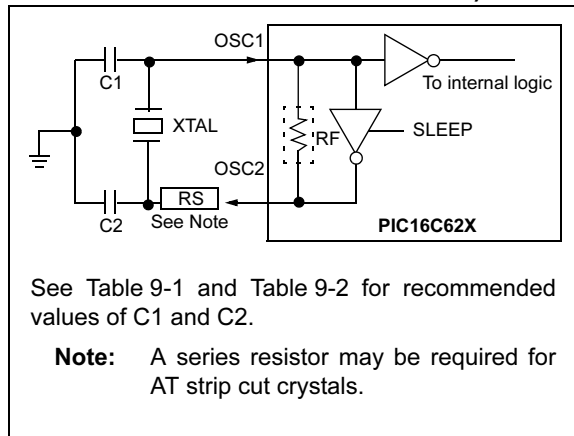
The PIC16C62X devices can be operated in four different oscillator options. The user can program two configuration bits (FOSC1 and FOSC0) to select one of these four modes:

- LP Low Power Crystal
- XT Crystal/Resonator
- HS High Speed Crystal/Resonator
- RC Resistor/Capacitor

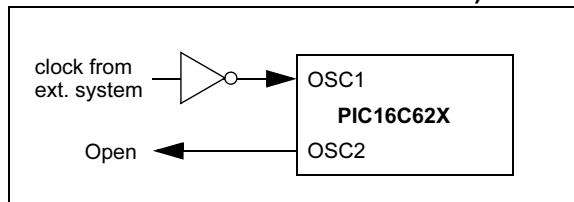
### 9.2.2 CRYSTAL OSCILLATOR / CERAMIC RESONATORS

In XT, LP or HS modes, a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation (Figure 9-1). The PIC16C62X oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT, LP or HS modes, the device can have an external clock source to drive the OSC1 pin (Figure 9-2).

**FIGURE 9-1: CRYSTAL OPERATION (OR CERAMIC RESONATOR) (HS, XT OR LP OSC CONFIGURATION)**



**FIGURE 9-2: EXTERNAL CLOCK INPUT OPERATION (HS, XT OR LP OSC CONFIGURATION)**



**TABLE 9-1: CAPACITOR SELECTION FOR CERAMIC RESONATORS**

Ranges Characterized:			
Mode	Freq	OSC1(C1)	OSC2(C2)
XT	455 kHz	22 - 100 pF	22 - 100 pF
	2.0 MHz	15 - 68 pF	15 - 68 pF
	4.0 MHz	15 - 68 pF	15 - 68 pF
HS	8.0 MHz	10 - 68 pF	10 - 68 pF
	16.0 MHz	10 - 22 pF	10 - 22 pF

Higher capacitance increases the stability of the oscillator but also increases the start-up time. These values are for design guidance only. Since each resonator has its own characteristics, the user should consult the resonator manufacturer for appropriate values of external components.

**TABLE 9-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR**

Mode	Freq	OSC1(C1)	OSC2(C2)
LP	32 kHz	68 - 100 pF	68 - 100 pF
	200 kHz	15 - 30 pF	15 - 30 pF
XT	100 kHz	68 - 150 pF	150 - 200 pF
	2 MHz	15 - 30 pF	15 - 30 pF
	4 MHz	15 - 30 pF	15 - 30 pF
HS	8 MHz	15 - 30 pF	15 - 30 pF
	10 MHz	15 - 30 pF	15 - 30 pF
	20 MHz	15 - 30 pF	15 - 30 pF

Higher capacitance increases the stability of the oscillator but also increases the start-up time. These values are for design guidance only. Rs may be required in HS mode as well as XT mode to avoid overdriving crystals with low drive level specification. Since each crystal has its own characteristics, the user should consult the crystal manufacturer for appropriate values of external components.



## 9.3 RESET

The PIC16C62X differentiates between various kinds of RESET:

- Power-on Reset (POR)
- $\overline{\text{MCLR}}$  Reset during normal operation
- $\overline{\text{MCLR}}$  Reset during SLEEP
- WDT Reset (normal operation)
- WDT wake-up (SLEEP)
- Brown-out Reset (BOR)

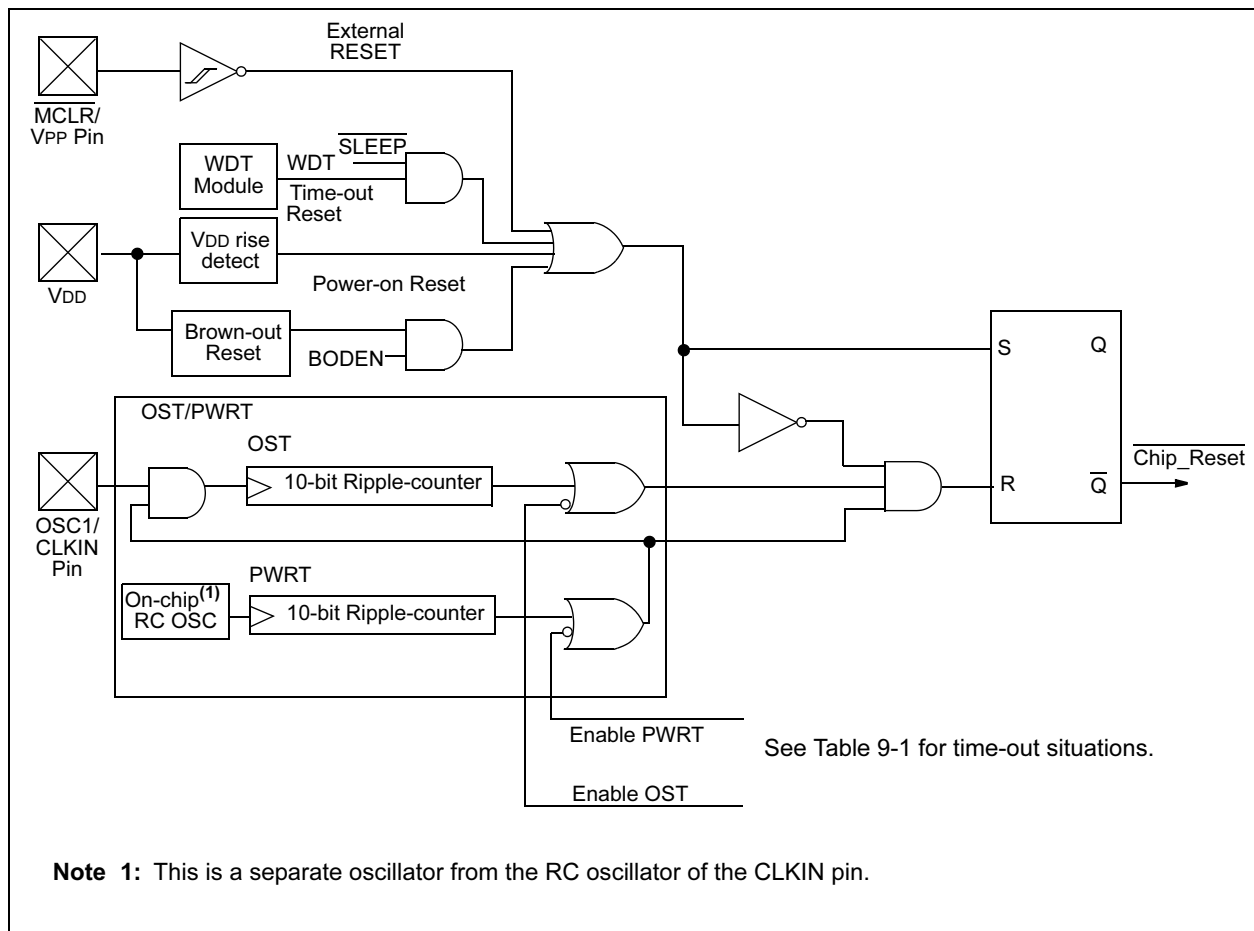
Some registers are not affected in any RESET condition. Their status is unknown on POR and unchanged in any other RESET. Most other registers are reset to a "RESET state" on Power-on Reset,

$\overline{\text{MCLR}}$  Reset, WDT Reset and  $\overline{\text{MCLR}}$  Reset during SLEEP. They are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation.  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits are set or cleared differently in different RESET situations as indicated in Table 9-2. These bits are used in software to determine the nature of the RESET. See Table 9-5 for a full description of RESET states of all registers.

A simplified block diagram of the on-chip RESET circuit is shown in Figure 9-6.

The  $\overline{\text{MCLR}}$  Reset path has a noise filter to detect and ignore small pulses. See Table 12-5 for pulse width specification.

**FIGURE 9-6: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT**



## 9.5 Interrupts

The PIC16C62X has 4 sources of interrupt:

- External interrupt RB0/INT
- TMR0 overflow interrupt
- PORTB change interrupts (pins RB<7:4>)
- Comparator interrupt

The interrupt control register (INTCON) records individual interrupt requests in flag bits. It also has individual and global interrupt enable bits.

A global interrupt enable bit, GIE (INTCON<7>) enables (if set) all un-masked interrupts or disables (if cleared) all interrupts. Individual interrupts can be disabled through their corresponding enable bits in INTCON register. GIE is cleared on RESET.

The “return from interrupt” instruction, RETFIE, exits interrupt routine, as well as sets the GIE bit, which re-enable RB0/INT interrupts.

The INT pin interrupt, the RB port change interrupt and the TMR0 overflow interrupt flags are contained in the INTCON register.

The peripheral interrupt flag is contained in the special register PIR1. The corresponding interrupt enable bit is contained in special registers PIE1.

When an interrupt is responded to, the GIE is cleared to disable any further interrupt, the return address is pushed into the stack and the PC is loaded with 0004h.

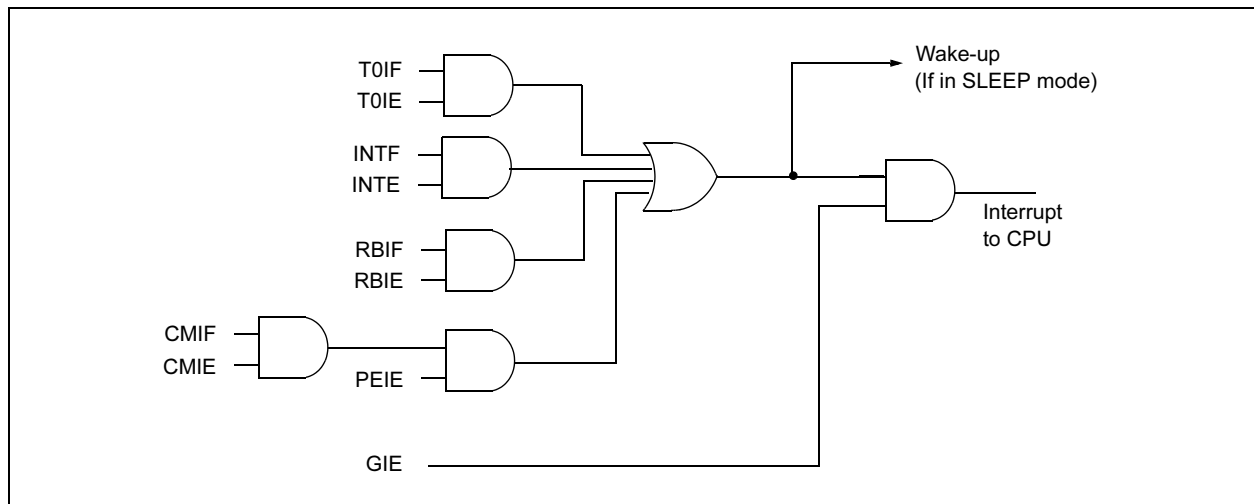
Once in the interrupt service routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid RB0/INT recursive interrupts.

For external interrupt events, such as the INT pin or PORTB change interrupt, the interrupt latency will be three or four instruction cycles. The exact latency depends when the interrupt event occurs (Figure 9-16). The latency is the same for one or two cycle instructions. Once in the interrupt service routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid multiple interrupt requests.

**Note 1:** Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.

**2:** When an instruction that clears the GIE bit is executed, any interrupts that were pending for execution in the next cycle are ignored. The CPU will execute a NOP in the cycle immediately following the instruction which clears the GIE bit. The interrupts which were ignored are still pending to be serviced when the GIE bit is set again.

**FIGURE 9-15: INTERRUPT LOGIC**



# PIC16C62X

**TABLE 10-2: PIC16C62X INSTRUCTION SET**

Mnemonic, Operands	Description	Cycles	14-Bit Opcode				Status Affected	Notes	
			MSb		LSb				
BYTE-ORIENTED FILE REGISTER OPERATIONS									
ADDWF	f, d	Add W and f	1	00	0111	dfff	ffff	C,DC,Z	1,2
ANDWF	f, d	AND W with f	1	00	0101	dfff	ffff	Z	1,2
CLRF	f	Clear f	1	00	0001	1fff	ffff	Z	2
CLRW	-	Clear W	1	00	0001	0000	0011	Z	
COMF	f, d	Complement f	1	00	1001	dfff	ffff	Z	1,2
DECf	f, d	Decrement f	1	00	0011	dfff	ffff	Z	1,2
DECFSZ	f, d	Decrement f, Skip if 0	1(2)	00	1011	dfff	ffff		1,2,3
INCF	f, d	Increment f	1	00	1010	dfff	ffff	Z	1,2
INCFSZ	f, d	Increment f, Skip if 0	1(2)	00	1111	dfff	ffff		1,2,3
IORWF	f, d	Inclusive OR W with f	1	00	0100	dfff	ffff	Z	1,2
MOVF	f, d	Move f	1	00	1000	dfff	ffff	Z	1,2
MOVWF	f	Move W to f	1	00	0000	1fff	ffff		
NOP	-	No Operation	1	00	0000	0xx0	0000		
RLF	f, d	Rotate Left f through Carry	1	00	1101	dfff	ffff	C	1,2
RRF	f, d	Rotate Right f through Carry	1	00	1100	dfff	ffff	C	1,2
SUBWF	f, d	Subtract W from f	1	00	0010	dfff	ffff	C,DC,Z	1,2
SWAPF	f, d	Swap nibbles in f	1	00	1110	dfff	ffff		1,2
XORWF	f, d	Exclusive OR W with f	1	00	0110	dfff	ffff	Z	1,2
BIT-ORIENTED FILE REGISTER OPERATIONS									
BCF	f, b	Bit Clear f	1	01	00bb	bfff	ffff		1,2
BSF	f, b	Bit Set f	1	01	01bb	bfff	ffff		1,2
BTFSC	f, b	Bit Test f, Skip if Clear	1 (2)	01	10bb	bfff	ffff		3
BTFSS	f, b	Bit Test f, Skip if Set	1 (2)	01	11bb	bfff	ffff		3
LITERAL AND CONTROL OPERATIONS									
ADDLW	k	Add literal and W	1	11	111x	kkkk	kkkk	C,DC,Z	
ANDLW	k	AND literal with W	1	11	1001	kkkk	kkkk	Z	
CALL	k	Call subroutine	2	10	0kkk	kkkk	kkkk		
CLRWDt	-	Clear Watchdog Timer	1	00	0000	0110	0100	$\overline{TO}, \overline{PD}$	
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk		
IORLW	k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z	
MOVLW	k	Move literal to W	1	11	00xx	kkkk	kkkk		
RETFIE	-	Return from interrupt	2	00	0000	0000	1001		
RETLW	k	Return with literal in W	2	11	01xx	kkkk	kkkk		
RETURN	-	Return from Subroutine	2	00	0000	0000	1000		
SLEEP	-	Go into Standby mode	1	00	0000	0110	0011	$\overline{TO}, \overline{PD}$	
SUBLW	k	Subtract W from literal	1	11	110x	kkkk	kkkk	C,DC,Z	
XORLW	k	Exclusive OR literal with W	1	11	1010	kkkk	kkkk	Z	

**Note 1:** When an I/O register is modified as a function of itself ( e.g., `MOVF PORTB, 1`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

- If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.
- If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

BTFSS		Bit Test f, Skip if Set						
Syntax:	[ <i>label</i> ] BTFSS f,b							
Operands:	$0 \leq f \leq 127$ $0 \leq b < 7$							
Operation:	skip if (f<b>) = 1							
Status Affected:	None							
Encoding:	<table border="1"><tr><td>01</td><td>11bb</td><td>bfff</td><td>ffff</td></tr></table>				01	11bb	bfff	ffff
01	11bb	bfff	ffff					
Description:	<p>If bit 'b' in register 'f' is '1', then the next instruction is skipped.</p> <p>If bit 'b' is '1', then the next instruction fetched during the current instruction execution, is discarded and a NOP is executed instead, making this a two-cycle instruction.</p>							
Words:	1							
Cycles:	1(2)							
Example	HERE	BTFSS	FLAG,1					
	FALSE	GOTO	PROCESS_CO					
	TRUE	•	DE					
		•						
		•						
Before Instruction								
PC = address HERE								
After Instruction								
if FLAG<1> = 0,								
PC = address FALSE								
if FLAG<1> = 1,								
PC = address TRUE								

CALL		Call Subroutine							
Syntax:	[ <i>label</i> ] CALL k								
Operands:	$0 \leq k \leq 2047$								
Operation:	(PC)+ 1 → TOS, k → PC<10:0>, (PCLATH<4:3>) → PC<12:11>								
Status Affected:	None								
Encoding:	<table border="1"><tr><td>10</td><td>0kkk</td><td>kkkk</td><td>kkkk</td></tr></table>					10	0kkk	kkkk	kkkk
10	0kkk	kkkk	kkkk						
Description:	Call Subroutine. First, return address (PC+1) is pushed onto the stack. The eleven bit immediate address is loaded into PC bits <10:0>. The upper bits of the PC are loaded from PCLATH. CALL is a two-cycle instruction.								
Words:	1								
Cycles:	2								
Example	<pre>HERE    CALL   THER                                 E</pre> <p>Before Instruction PC = Address HERE</p> <p>After Instruction PC = Address THERE TOS = Address HERE+1</p>								

CLRF		Clear f						
Syntax:	[ <i>label</i> ] CLRF    f							
Operands:	$0 \leq f \leq 127$							
Operation:	00h → (f) 1 → Z							
Status Affected:	Z							
Encoding:	<table border="1"><tr><td>00</td><td>0001</td><td>1fff</td><td>ffff</td></tr></table>				00	0001	1fff	ffff
00	0001	1fff	ffff					
Description:	The contents of register 'f' are cleared and the Z bit is set.							
Words:	1							
Cycles:	1							
Example	<pre>CLRF    FLAG_REG</pre> <p>Before Instruction</p> <p>FLAG_REG = 0x5A</p> <p>After Instruction</p> <p>FLAG_REG = 0x00</p> <p>Z = 1</p>							

# PIC16C62X

## INCFSZ Increment f, Skip if 0

Syntax:	[ <i>label</i> ] INCFSZ f,d				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	$(f) + 1 \rightarrow (\text{dest})$ , skip if result = 0				
Status Affected:	None				
Encoding:	<table border="1"><tr><td>00</td><td>1111</td><td>dfff</td><td>ffff</td></tr></table>	00	1111	dfff	ffff
00	1111	dfff	ffff		
Description:	<p>The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.</p> <p>If the result is 0, the next instruction, which is already fetched, is discarded. A NOP is executed instead making it a two-cycle instruction.</p>				
Words:	1				
Cycles:	1(2)				
Example	<pre>HERE      INCFSZ    CNT, 1           GOTO      LOOP CONTINUE  •           •           •</pre>				

Before Instruction  
PC = address HERE

After Instruction  
CNT = CNT + 1  
if CNT= 0,  
PC = address CONTINUE  
if CNT≠ 0,  
PC = address HERE +1

## IORLW Inclusive OR Literal with W

Syntax:	[ <i>label</i> ] IORLW k			
Operands:	$0 \leq k \leq 255$			
Operation:	(W) .OR. k $\rightarrow$ (W)			
Status Affected:	Z			
Encoding:	11	1000	kkkk	kkkk
Description:	The contents of the W register is OR'ed with the eight bit literal 'k'. The result is placed in the W register.			
Words:	1			
Cycles:	1			
Example	IORLW 0x35			
	Before Instruction			
	W = 0x9A			
	After Instruction			
	W = 0xBF			
	Z = 1			

## IORWF Inclusive OR W with f

Syntax:	[ <i>label</i> ] IORWF f,d															
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$															
Operation:	(W) .OR. (f) $\rightarrow$ (dest)															
Status Affected:	$\bar{Z}$															
Encoding:	<table border="1"><tr><td>00</td><td>0100</td><td>dfff</td><td>ffff</td></tr></table>	00	0100	dfff	ffff											
00	0100	dfff	ffff													
Description:	Inclusive OR the W register with register 'f'. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.															
Words:	1															
Cycles:	1															
Example	<pre> IORWF    RESULT, 0 </pre> <p>Before Instruction</p> <table><tr><td>RESULT</td><td>=</td><td>0x13</td></tr><tr><td>W</td><td>=</td><td>0x91</td></tr></table> <p>After Instruction</p> <table><tr><td>RESULT</td><td>=</td><td>0x13</td></tr><tr><td>W</td><td>=</td><td>0x93</td></tr><tr><td>Z</td><td>=</td><td>1</td></tr></table>	RESULT	=	0x13	W	=	0x91	RESULT	=	0x13	W	=	0x93	Z	=	1
RESULT	=	0x13														
W	=	0x91														
RESULT	=	0x13														
W	=	0x93														
Z	=	1														

## MOVLW Move Literal to W

Syntax:	[ <i>label</i> ] MOVLW k			
Operands:	$0 \leq k \leq 255$			
Operation:	$k \rightarrow (W)$			
Status Affected:	None			
Encoding:	11	00xx	kkkk	kkkk
Description:	The eight bit literal 'k' is loaded into W register. The don't cares will assemble as 0's.			
Words:	1			
Cycles:	1			
Example	MOVLW 0x5A			
	After Instruction			
	W = 0x5A			

MOVF		Move f			
Syntax:	[ <i>label</i> ] MOVF f,d				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	(f) $\rightarrow$ (dest)				
Status Affected:	Z				
Encoding:	00	1000	dfff	ffff	
Description:	The contents of register f is moved to a destination dependent upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.				
Words:	1				
Cycles:	1				
Example	MOVF FSR, 0				
	After Instruction				
	W	=	value in FSR		
	register				
	Z	=	1		

MOVWF	Move W to f				
Syntax:	[ <i>label</i> ] MOVWF f				
Operands:	0 ≤ f ≤ 127				
Operation:	(W) → (f)				
Status Affected:	None				
Encoding:	<table><tr><td>00</td><td>0000</td><td>1fff</td><td>ffff</td></tr></table>	00	0000	1fff	ffff
00	0000	1fff	ffff		
Description:	Move data from W register to register 'f'.				
Words:	1				
Cycles:	1				
Example	MOVWF OPTION Before Instruction OPTION = 0xFF W = 0x4F After Instruction OPTION = 0x4F W = 0x4F				

NOP	No Operation			
Syntax:	[ <i>label</i> ] NOP			
Operands:	None			
Operation:	No operation			
Status Affected:	None			
Encoding:	00	0000	0xx0	0000
Description:	No operation.			
Words:	1			
Cycles:	1			
Example	NOP			

OPTION	Load Option Register				
Syntax:	[ <i>label</i> ] OPTION				
Operands:	None				
Operation:	(W) → OPTION				
Status Affected:	None				
Encoding:	<table><tr><td>00</td><td>0000</td><td>0110</td><td>0010</td></tr></table>	00	0000	0110	0010
00	0000	0110	0010		
Description:	<p>The contents of the W register are loaded in the OPTION register.</p> <p>This instruction is supported for code compatibility with PIC16C5X products. Since OPTION is a readable/writable register, the user can directly address it.</p>				
Words:	1				
Cycles:	1				
Example	<div><b>To maintain upward compatibility with future PICmicro<sup>®</sup> products, do not use this instruction.</b></div>				

## 11.0 DEVELOPMENT SUPPORT

The PICmicro® microcontrollers are supported with a full range of hardware and software development tools:

- Integrated Development Environment
  - MPLAB® IDE Software
- Assemblers/Compilers/Linkers
  - MPASM™ Assembler
  - MPLAB C17 and MPLAB C18 C Compilers
  - MPLINK™ Object Linker/  
MPLIB™ Object Librarian
  - MPLAB C30 C Compiler
  - MPLAB ASM30 Assembler/Linker/Library
- Simulators
  - MPLAB SIM Software Simulator
  - MPLAB dsPIC30 Software Simulator
- Emulators
  - MPLAB ICE 2000 In-Circuit Emulator
  - MPLAB ICE 4000 In-Circuit Emulator
- In-Circuit Debugger
  - MPLAB ICD 2
- Device Programmers
  - PRO MATE® II Universal Device Programmer
  - PICSTART® Plus Development Programmer
- Low Cost Demonstration Boards
  - PICDEM™ 1 Demonstration Board
  - PICDEM.net™ Demonstration Board
  - PICDEM 2 Plus Demonstration Board
  - PICDEM 3 Demonstration Board
  - PICDEM 4 Demonstration Board
  - PICDEM 17 Demonstration Board
  - PICDEM 18R Demonstration Board
  - PICDEM LIN Demonstration Board
  - PICDEM USB Demonstration Board
- Evaluation Kits
  - KEELOQ®
  - PICDEM MSC
  - microID®
  - CAN
  - PowerSmart®
  - Analog

## 11.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16-bit microcontroller market. The MPLAB IDE is a Windows® based application that contains:

- An interface to debugging tools
  - simulator
  - programmer (sold separately)
  - emulator (sold separately)
  - in-circuit debugger (sold separately)
- A full-featured editor with color coded context
- A multiple project manager
- Customizable data windows with direct edit of contents
- High level source code debugging
- Mouse over variable inspection
- Extensive on-line help

The MPLAB IDE allows you to:

- Edit your source files (either assembly or C)
- One touch assemble (or compile) and download to PICmicro emulator and simulator tools (automatically updates all project information)
- Debug using:
  - source files (assembly or C)
  - absolute listing file (mixed assembly and C)
  - machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost effective simulators, through low cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increasing flexibility and power.

## 11.2 MPASM Assembler

The MPASM assembler is a full-featured, universal macro assembler for all PICmicro MCUs.

The MPASM assembler generates relocatable object files for the MPLINK object linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM assembler features include:

- Integration into MPLAB IDE projects
- User defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

# PIC16C62X

## 12.2 DC Characteristics: PIC16C62XA-04 (Commercial, Industrial, Extended) PIC16C62XA-20 (Commercial, Industrial, Extended) PIC16LC62XA-04 (Commercial, Industrial, Extended (CONT.))

PIC16C62XA			Standard Operating Conditions (unless otherwise stated)				
			Operating temperature -40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial and -40°C ≤ TA ≤ +125°C for extended				
PIC16LC62XA			Standard Operating Conditions (unless otherwise stated)				
			Operating temperature -40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial and -40°C ≤ TA ≤ +125°C for extended				
Param. No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D022	ΔI <sub>WDT</sub>	WDT Current <sup>(5)</sup>	—	6.0	10	μA	V <sub>DD</sub> = 4.0V (125°C)
D022A	ΔI <sub>BOR</sub>	Brown-out Reset Current <sup>(5)</sup>	—	75	125	μA	BOD enabled, V <sub>DD</sub> = 5.0V
D023	ΔI <sub>COMP</sub>	Comparator Current for each Comparator <sup>(5)</sup>	—	30	60	μA	V <sub>DD</sub> = 4.0V
D023A	ΔI <sub>VREF</sub>	VREF Current <sup>(5)</sup>	—	80	135	μA	V <sub>DD</sub> = 4.0V
D022	ΔI <sub>WDT</sub>	WDT Current <sup>(5)</sup>	—	6.0	10	μA	V <sub>DD</sub> =4.0V (125°C)
D022A	ΔI <sub>BOR</sub>	Brown-out Reset Current <sup>(5)</sup>	—	75	125	μA	BOD enabled, V <sub>DD</sub> = 5.0V
D023	ΔI <sub>COMP</sub>	Comparator Current for each Comparator <sup>(5)</sup>	—	30	60	μA	V <sub>DD</sub> = 4.0V
D023A	ΔI <sub>VREF</sub>	VREF Current <sup>(5)</sup>	—	80	135	μA	V <sub>DD</sub> = 4.0V
1A	FOSC	LP Oscillator Operating Frequency	0	—	200	kHz	All temperatures
		RC Oscillator Operating Frequency	0	—	4	MHz	All temperatures
		XT Oscillator Operating Frequency	0	—	4	MHz	All temperatures
		HS Oscillator Operating Frequency	0	—	20	MHz	All temperatures
1A	FOSC	LP Oscillator Operating Frequency	0	—	200	kHz	All temperatures
		RC Oscillator Operating Frequency	0	—	4	MHz	All temperatures
		XT Oscillator Operating Frequency	0	—	4	MHz	All temperatures
		HS Oscillator Operating Frequency	0	—	20	MHz	All temperatures

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** This is the limit to which V<sub>DD</sub> can be lowered without losing RAM data.

**2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all I<sub>DD</sub> measurements in Active Operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to V<sub>DD</sub>,

MCLR = V<sub>DD</sub>; WDT enabled/disabled as specified.

**3:** The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to V<sub>DD</sub> or V<sub>SS</sub>.

**4:** For RC osc configuration, current through R<sub>EXT</sub> is not included. The current through the resistor can be estimated by the formula: I<sub>r</sub> = V<sub>DD</sub>/2R<sub>EXT</sub> (mA) with R<sub>EXT</sub> in kΩ.

**5:** The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base I<sub>DD</sub> or I<sub>PD</sub> measurement.

**6:** Commercial temperature range only.



## 12.5 DC CHARACTERISTICS: PIC16C620A/C621A/C622A-40<sup>(7)</sup> (Commercial) PIC16CR620A-40<sup>(7)</sup> (Commercial)

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated)				
			Operating temperature 0°C ≤ TA ≤ +70°C for commercial				
Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D001	VDD	Supply Voltage	3.0	—	5.5	V	FOSC = DC to 20 MHz
D002	VDR	RAM Data Retention Voltage <sup>(1)</sup>	—	1.5*	—	V	Device in SLEEP mode
D003	VPOR	VDD start voltage to ensure Power-on Reset	—	VSS	—	V	See section on Power-on Reset for details
D004	SVDD	VDD rise rate to ensure Power-on Reset	0.05*	—	—	V/ms	See section on Power-on Reset for details
D005	VBOR	Brown-out Detect Voltage	3.65	4.0	4.35	V	BOREN configuration bit is cleared
D010	IDD	Supply Current <sup>(2,4)</sup>	—	1.2	2.0	mA	FOSC = 4 MHz, VDD = 5.5V, WDT disabled, XT Osc mode, <b>(Note 4)*</b>
			—	0.4	1.2	mA	FOSC = 4 MHz, VDD = 3.0V, WDT disabled, XT Osc mode, <b>(Note 4)</b>
			—	1.0	2.0	mA	FOSC = 10 MHz, VDD = 3.0V, WDT disabled, HS Osc mode, <b>(Note 6)</b>
			—	4.0	6.0	mA	FOSC = 20 MHz, VDD = 4.5V, WDT disabled, HS Osc mode
			—	4.0	7.0	mA	FOSC = 20 MHz, VDD = 5.5V, WDT disabled*, HS Osc mode
			—	35	70	μA	FOSC = 32 kHz, VDD = 3.0V, WDT disabled, LP Osc mode
D020	IPD	Power Down Current <sup>(3)</sup>	—	—	2.2	μA	VDD = 3.0V
			—	—	5.0	μA	VDD = 4.5V*
			—	—	9.0	μA	VDD = 5.5V
			—	—	15	μA	VDD = 5.5V Extended
D022	ΔI <sub>WDT</sub>	WDT Current <sup>(5)</sup>	—	6.0	10	μA	VDD = 4.0V
D022A	ΔI <sub>BOR</sub>	Brown-out Reset Current <sup>(5)</sup>	—	75	125	μA	(125°C)
D023	ΔI <sub>COMP</sub>	Comparator Current for each Comparator <sup>(5)</sup>	—	30	60	μA	BOD enabled, VDD = 5.0V
D023A	ΔI <sub>VREF</sub>	VREF Current <sup>(5)</sup>	—	80	135	μA	VDD = 4.0V
	ΔI <sub>EE Write</sub>	Operating Current	—	—	3	mA	VCC = 5.5V, SCL = 400 kHz
	ΔI <sub>EE Read</sub>	Operating Current	—	—	1	mA	
	ΔI <sub>EE</sub>	Standby Current	—	—	30	μA	VCC = 3.0V, EE VDD = VCC
	ΔI <sub>EE</sub>	Standby Current	—	—	100	μA	VCC = 3.0V, EE VDD = VCC
1A	FOSC	LP Oscillator Operating Frequency	0	—	200	kHz	All temperatures
		RC Oscillator Operating Frequency	0	—	4	MHz	All temperatures
		XT Oscillator Operating Frequency	0	—	4	MHz	All temperatures
		HS Oscillator Operating Frequency	0	—	20	MHz	All temperatures

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

**Note 2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in Active Operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; MCLR = VDD; WDT enabled/disabled as specified.

**Note 3:** The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or VSS.

**Note 4:** For RC OSC configuration, current through REXT is not included. The current through the resistor can be estimated by the formula  $I_r = V_{DD} / 2R_{EXT}$  (mA) with REXT in kΩ.

**Note 5:** The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

**Note 6:** Commercial temperature range only.

**Note 7:** See Section 12.1 and Section 12.3 for 16C62X and 16CR62X devices for operation between 20 MHz and 40 MHz for valid modified characteristics.

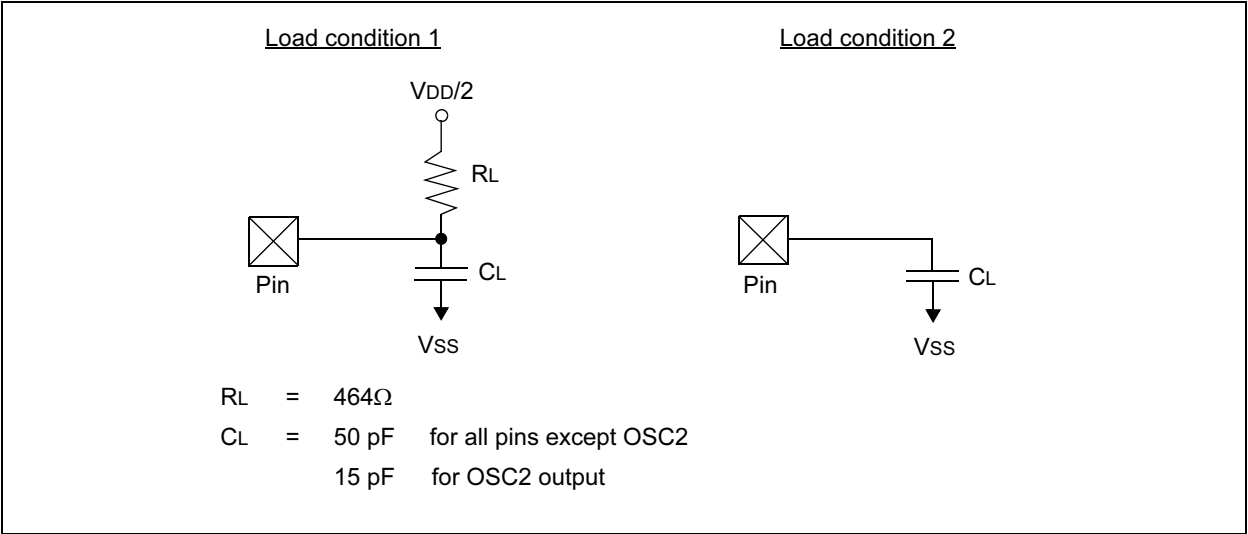
12.8 Timing Parameter Symbolology

The timing parameter symbols have been created with one of the following formats:

- 1. TppS2ppS
- 2. TppS

<b>T</b>			
F	Frequency	T	Time
Lowercase subscripts (pp) and their meanings:			
<b>pp</b>			
ck	CLKOUT	osc	OSC1
io	I/O port	t0	T0CKI
mc	MCLR		
Uppercase letters and their meanings:			
<b>S</b>			
F	Fall	P	Period
H	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-Impedance

FIGURE 12-11: LOAD CONDITIONS



# PIC16C62X

FIGURE 13-3: I<sub>DD</sub> VS. V<sub>DD</sub> (XT OSC 4 MHZ)

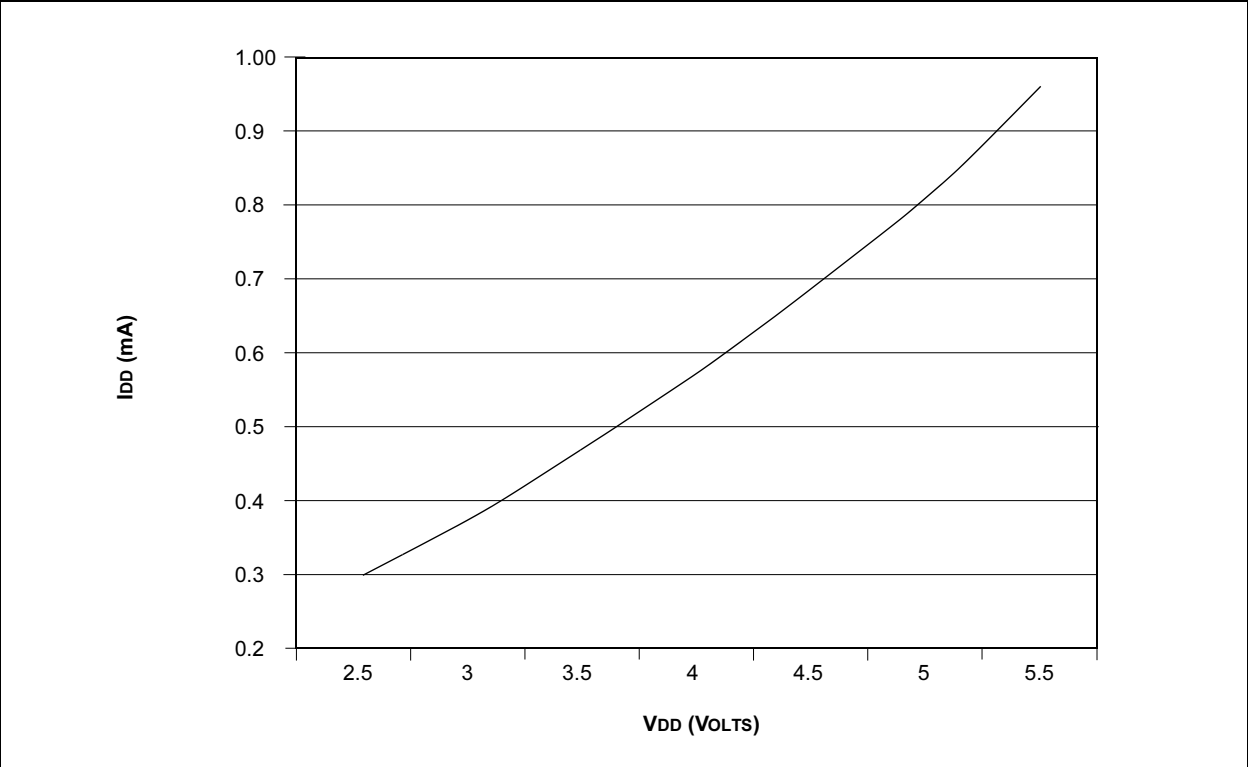
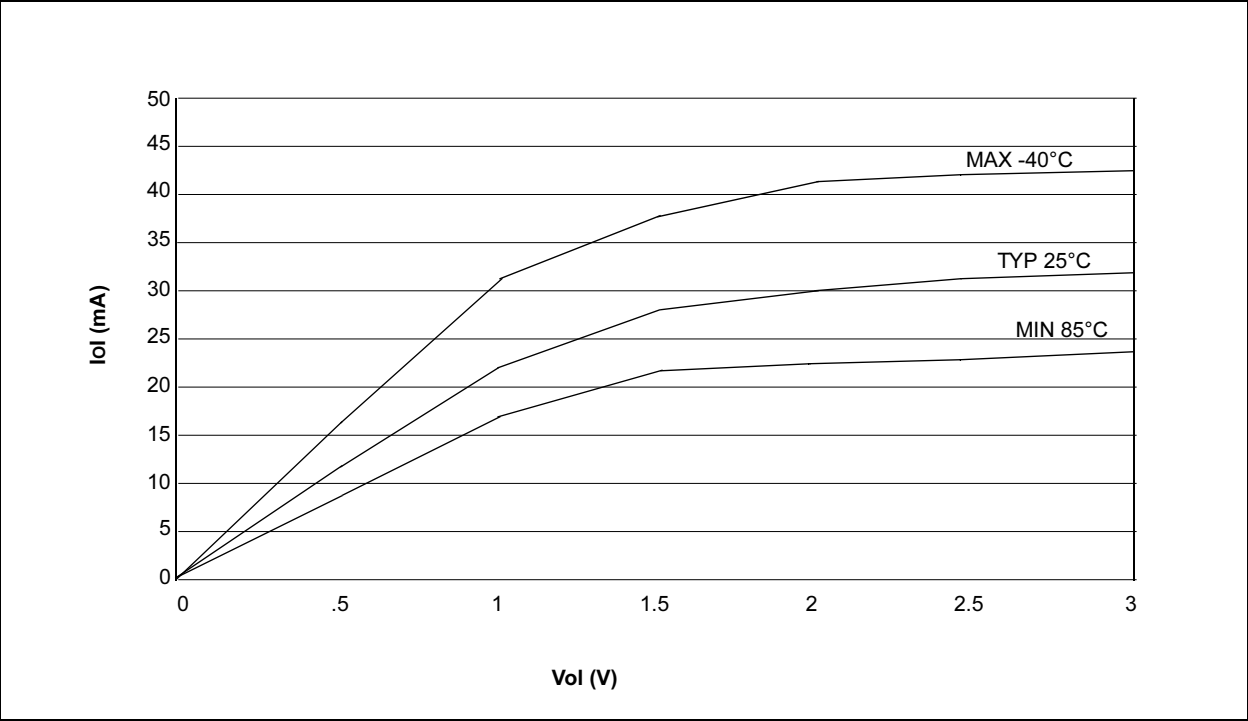


FIGURE 13-4: I<sub>OL</sub> vs. V<sub>OL</sub>, V<sub>DD</sub> = 3.0V



# PIC16C62X

---

NOTES:

# PIC16C62X

---

## N

NOP Instruction ..... 69

## O

One-Time-Programmable (OTP) Devices ..... 7

OPTION Instruction ..... 69

OPTION Register ..... 19

Oscillator Configurations ..... 47

Oscillator Start-up Timer (OST) ..... 50

## P

Package Marking Information ..... 117

Packaging Information ..... 113

PCL and PCLATH ..... 23

PCON Register ..... 22

PICKit 1 FLASH Starter Kit ..... 79

PICSTART Plus Development Programmer ..... 77

PIE1 Register ..... 21

PIR1 Register ..... 21

Port RB Interrupt ..... 56

PORTA ..... 25

PORTB ..... 28

Power Control/Status Register (PCON) ..... 51

Power-Down Mode (SLEEP) ..... 59

Power-On Reset (POR) ..... 50

Power-up Timer (PWRT) ..... 50

Prescaler ..... 34

PRO MATE II Universal Device Programmer ..... 77

Program Memory Organization ..... 13

## Q

Quick-Turnaround-Production (QTP) Devices ..... 7

## R

RC Oscillator ..... 48

Reset ..... 49

RETFIE Instruction ..... 70

RETLW Instruction ..... 70

RETURN Instruction ..... 70

RLF Instruction ..... 71

RRF Instruction ..... 71

## S

Serialized Quick-Turnaround-Production (SQTP) Devices ... 7

SLEEP Instruction ..... 71

Software Simulator (MPLAB SIM) ..... 76

Software Simulator (MPLAB SIM30) ..... 76

Special Features of the CPU ..... 45

Special Function Registers ..... 17

Stack ..... 23

Status Register ..... 18

SUBLW Instruction ..... 72

SUBWF Instruction ..... 72

SWAPF Instruction ..... 73

## T

Timer0

TIMER0 ..... 31

TIMER0 (TMR0) Interrupt ..... 31

TIMER0 (TMR0) Module ..... 31

TMR0 with External Clock ..... 33

Timer1

Switching Prescaler Assignment ..... 35

Timing Diagrams and Specifications ..... 104

TMR0 Interrupt ..... 56

TRIS Instruction ..... 73

TRISA ..... 25

TRISB ..... 28

## V

Voltage Reference Module ..... 43

VRCON Register ..... 43

## W

Watchdog Timer (WDT) ..... 58

WWW, On-Line Support ..... 3

## X

XORLW Instruction ..... 73

XORWF Instruction ..... 73